

Dual P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY		
V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)
- 20	0.490 at $V_{GS} = - 4.5$ V	- 1.0
	0.750 at $V_{GS} = - 2.5$ V	- 0.81
	1.10 at $V_{GS} = - 1.8$ V	- 0.67

FEATURES

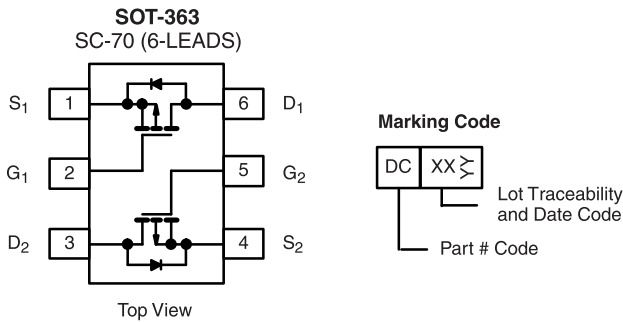
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFETs: 1.8 V Rated
- Thermally Enhanced SC-70 Package
- Compliant to RoHS Directive 2002/95/EC



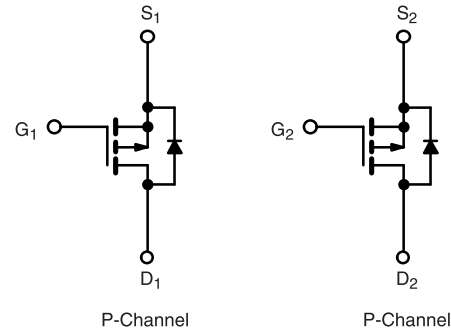
RoHS
COMPLIANT
HALOGEN
FREE
Available

APPLICATIONS

- Load Switching
- PA Switch
- Level Switch



Ordering Information: Si1913DH-T1-E3 (Lead (Pb)-free)
Si1913DH-T1-GE3 (Lead (Pb)-free and Halogen-free)



ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted					
Parameter	Symbol	5 s	Steady State	Unit	
Drain-Source Voltage	V_{DS}	- 20		V	
Gate-Source Voltage	V_{GS}	± 8			
Continuous Drain Current ($T_J = 150$ °C) ^a	I_D	$T_A = 25$ °C	- 1.0	- 0.88	A
		$T_A = 85$ °C	- 0.72	- 0.63	
Pulsed Drain Current	I_{DM}	- 3			
Continuous Diode Current (Diode Conduction) ^a	I_S	- 0.61	- 0.48		
Maximum Power Dissipation ^a	P_D	$T_A = 25$ °C	0.74	0.57	W
		$T_A = 85$ °C	0.38	0.30	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 150		°C	

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	R_{thJA}	$t \leq 5$ s	130	170	°C/W
		Steady State	170	220	
Maximum Junction-to-Foot (Drain)	R_{thJF}	80	100		

Notes:

a. Surface mounted on 1" x 1" FR4 board.

SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -100\ \mu\text{A}$	-0.45		-1	V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\ \text{V}, V_{GS} = \pm 8\ \text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -16\ \text{V}, V_{GS} = 0\ \text{V}$			-1	μA
		$V_{DS} = -16\ \text{V}, V_{GS} = 0\ \text{V}, T_J = 85\text{ }^\circ\text{C}$			-5	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} = -5\ \text{V}, V_{GS} = -4.5\ \text{V}$	-2			A
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = -4.5\ \text{V}, I_D = -0.88\ \text{A}$		0.400	0.490	Ω
		$V_{GS} = -2.5\ \text{V}, I_D = -0.71\ \text{A}$		0.610	0.750	
		$V_{GS} = -1.8\ \text{V}, I_D = -0.2\ \text{A}$		0.850	1.10	
Forward Transconductance ^a	g_{fs}	$V_{DS} = -10\ \text{V}, I_D = -0.88\ \text{A}$		1.5		S
Diode Forward Voltage ^a	V_{SD}	$I_S = -0.47\ \text{A}, V_{GS} = 0\ \text{V}$		-0.85	-1.2	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = -10\ \text{V}, V_{GS} = -4.5\ \text{V}, I_D = -0.88\ \text{A}$		1.2	1.8	nC
Gate-Source Charge	Q_{gs}			0.3		
Gate-Drain Charge	Q_{gd}			0.21		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -10\ \text{V}, R_L = 20\ \Omega$ $I_D \cong -0.5\ \text{A}, V_{GEN} = -4.5\ \text{V}, R_g = 6\ \Omega$		18	30	ns
Rise Time	t_r			25	40	
Turn-Off Delay Time	$t_{d(off)}$			15	45	
Fall Time	t_f			12	20	
Reverse Recovery Time	t_{rr}	$I_F = 0.47\ \text{A}, di/dt = 100\ \text{A}/\mu\text{s}$		30	60	

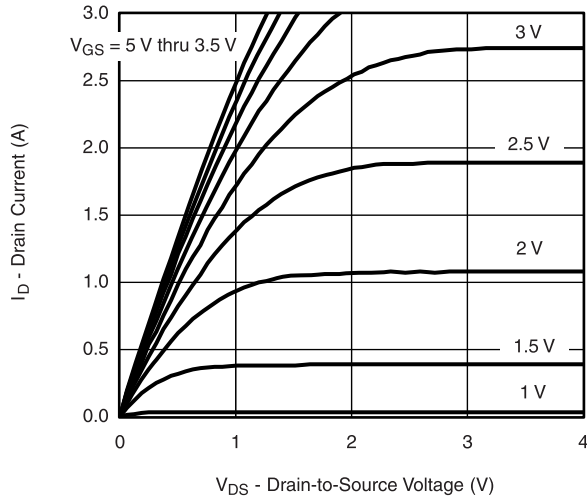
Notes:

a. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.

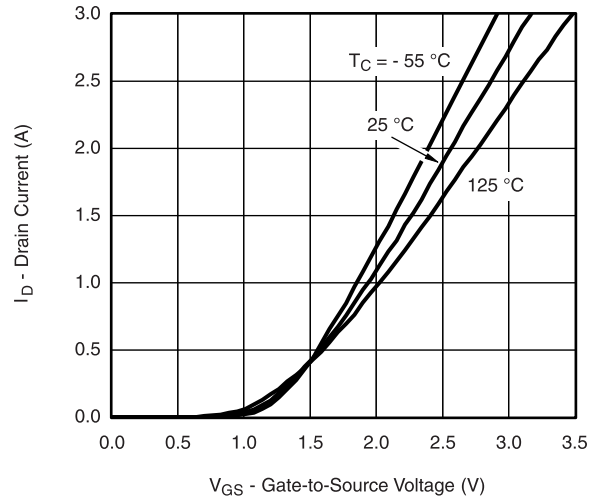
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

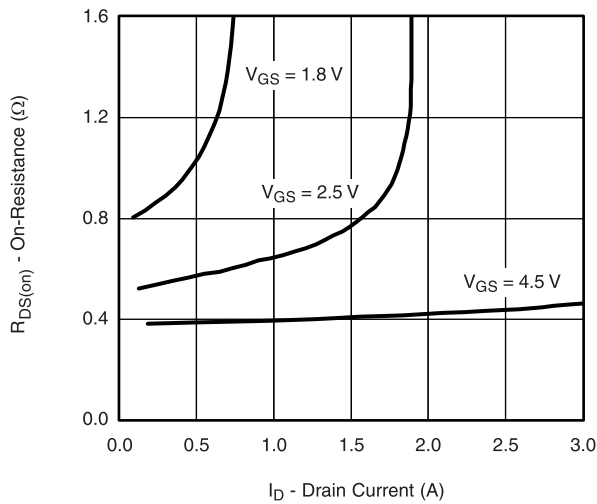
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



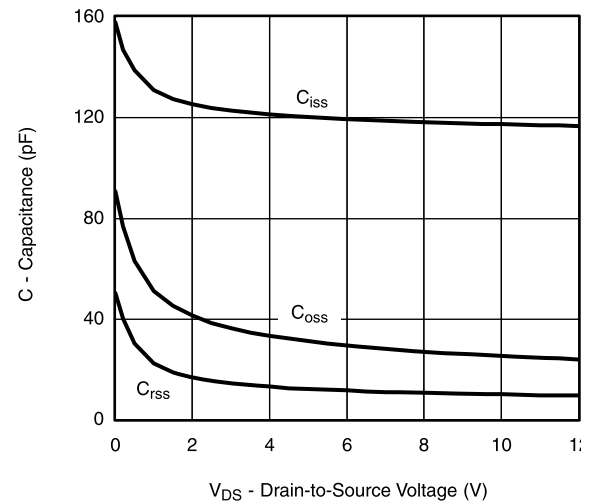
Output Characteristics



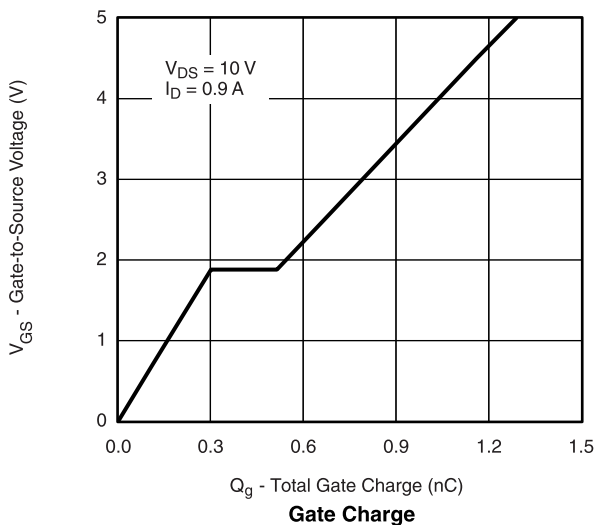
Transfer Characteristics



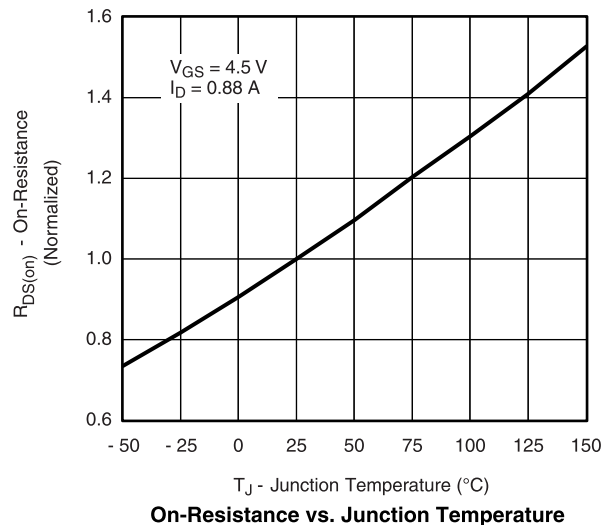
On-Resistance vs. Drain Current



Capacitance

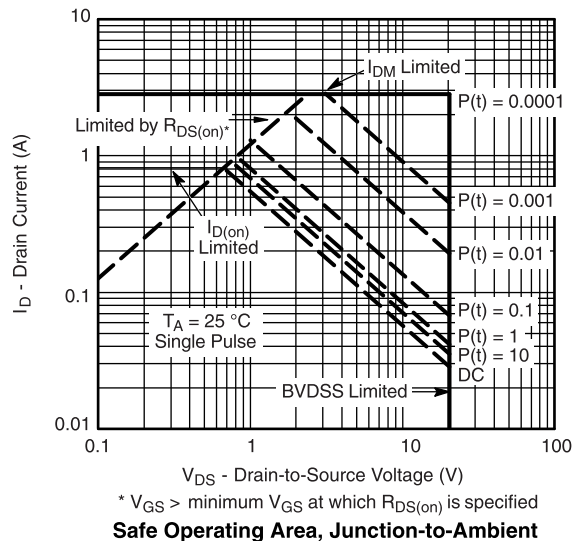
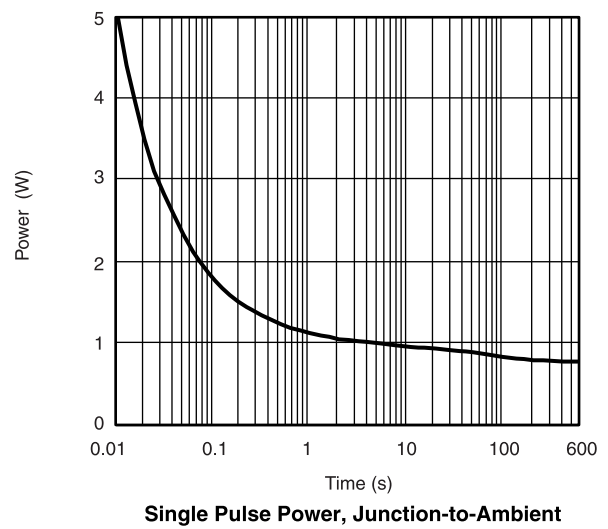
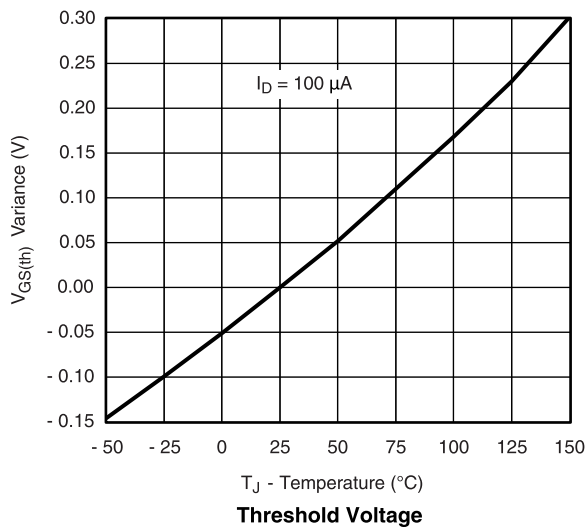
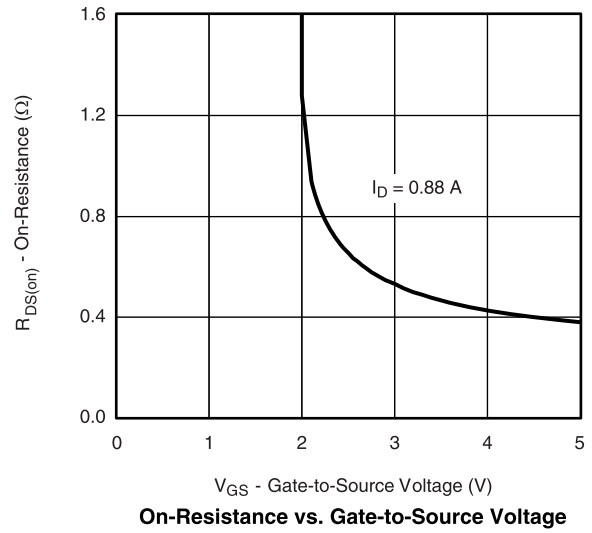
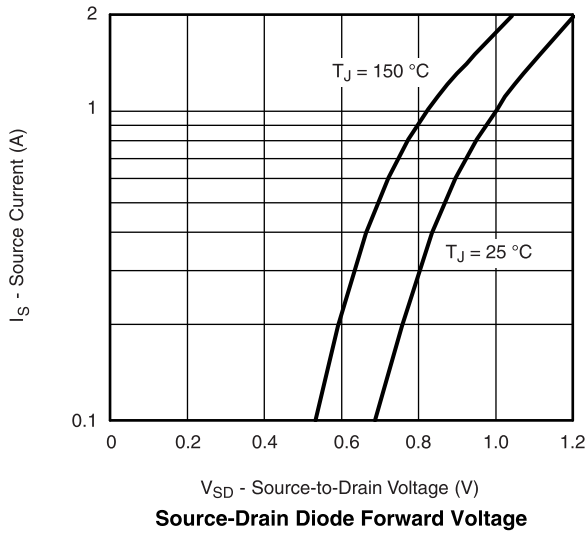


Gate Charge

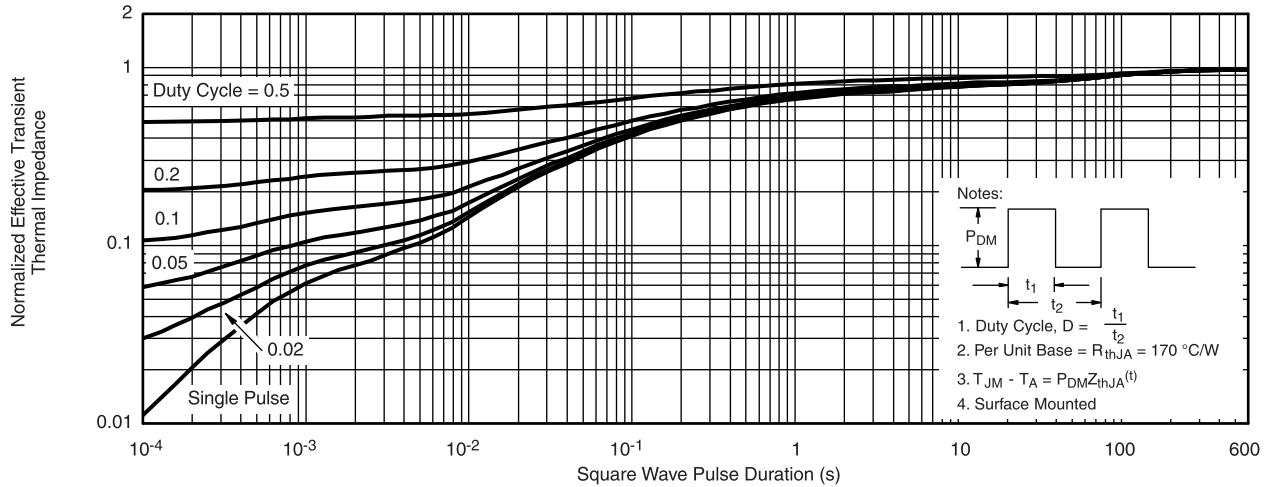


On-Resistance vs. Junction Temperature

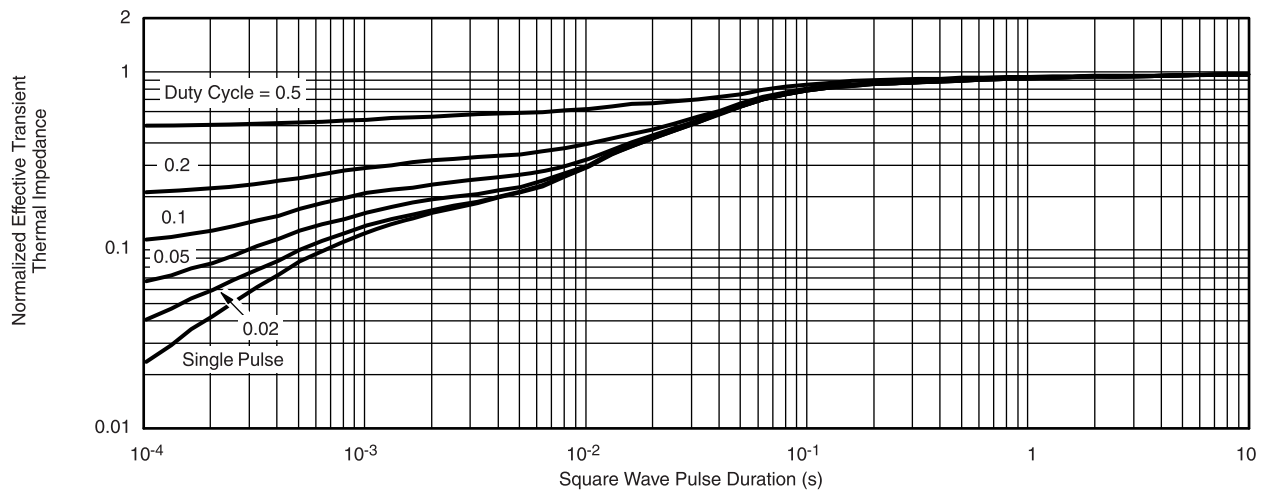
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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